



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Grigg et al.

Serial No.: 10/688,354

Filed: October 17, 2003

For: THICK SOLDER MASK FOR
CONFINING ENCAPSULANT MATERIAL
OVER SELECTED LOCATIONS OF A
SUBSTRATE AND ASSEMBLIES
INCLUDING THE SOLDER MASK

Confirmation No.: 2306

Examiner: C. Wilson

Group Art Unit: 2826

Attorney Docket No.: 2269-5216.1US
(99-0507.01/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

June 9, 2005
Date

Signature

Denise Dyer
Name (Type/Print)

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Sir:

The following amendments and remarks are filed in response to the Examiner's remarks in the Office Action mailed March 14, 2005, the three-month shortened statutory period for response to which expires on June 14, 2005.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.